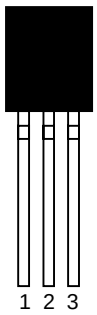
DS1815
3.3V EconoReset with Push-Pull Output

www.dalsemi.com

FEATURES

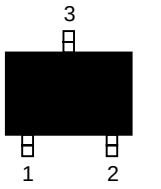
- Automatically restarts a microprocessor after power failure
- Maintains reset for 150 ms after V_{CC} returns to an in-tolerance condition
- Reduces need for discrete components
- Precision temperature-compensated voltage reference and voltage sensor
- Accurate 5%, 10% or 20% power monitoring
- Low-cost TO-92 or space saving surface-mount SOT-23 packages available
- Push-pull output for low current operation
- Operating temperature -40°C to +85°C

PIN ASSIGNMENT





TO-92 PACKAGE
See Mech.
Drawings Section



SOT-23 PACKAGE

PIN DESCRIPTION

TO-92

1	$\overline{RST}$	Active Low Reset Output
2	V_{CC}	Power Supply
3	GND	Ground

SOT-23

1	$\overline{RST}$	Active Low Reset Output
2	V_{CC}	Power Supply
3	GND	Ground

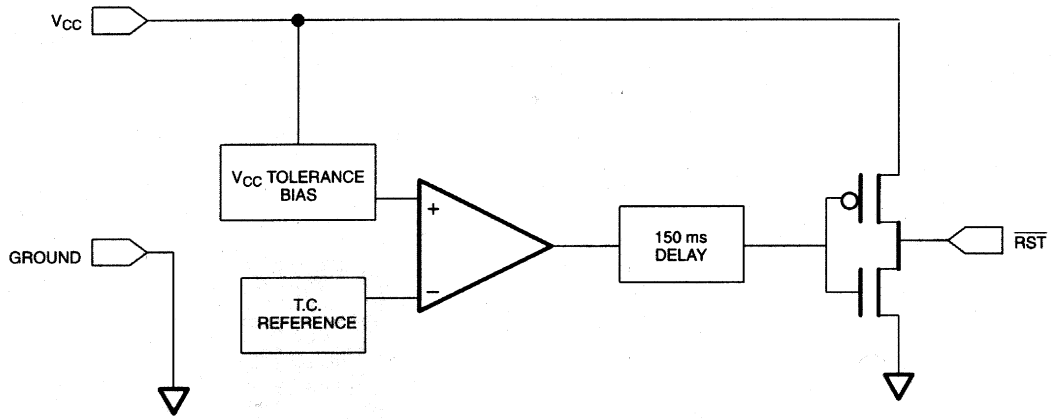
DESCRIPTION

The DS1815 EconoReset uses a precision temperature reference and comparator circuit to monitor the status of the power supply (V_{CC}). When an out-of-tolerance condition is detected, an internal power-fail signal is generated which forces reset to the active state. When V_{CC} returns to an in-tolerance condition, the reset signal is kept in the active state for approximately 150 ms to allow the power supply and processor to stabilize.

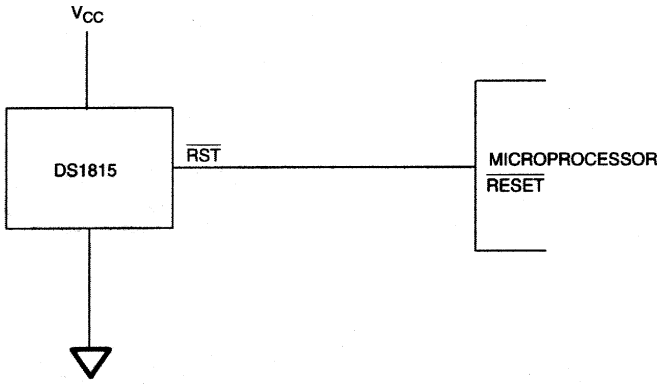
OPERATION - POWER MONITOR

The DS1815 provides the functions of detecting out-of-tolerance power supply conditions and warning a processor-based system of impending power failure. When V_{CC} is detected as out of tolerance, the $\overline{RST}$ signal is asserted. On power-up, $\overline{RST}$ is kept active for approximately 150 ms after the power supply has reached the selected tolerance. This allows the power supply and microprocessor to stabilize before $\overline{RST}$ is released.

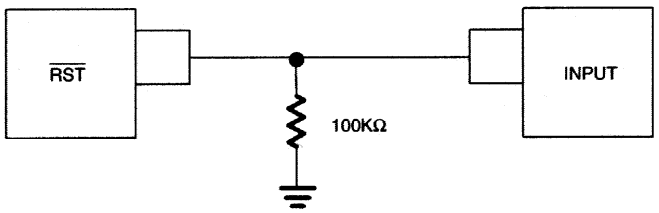
BLOCK DIAGRAM (CMOS OUTPUT) Figure 1



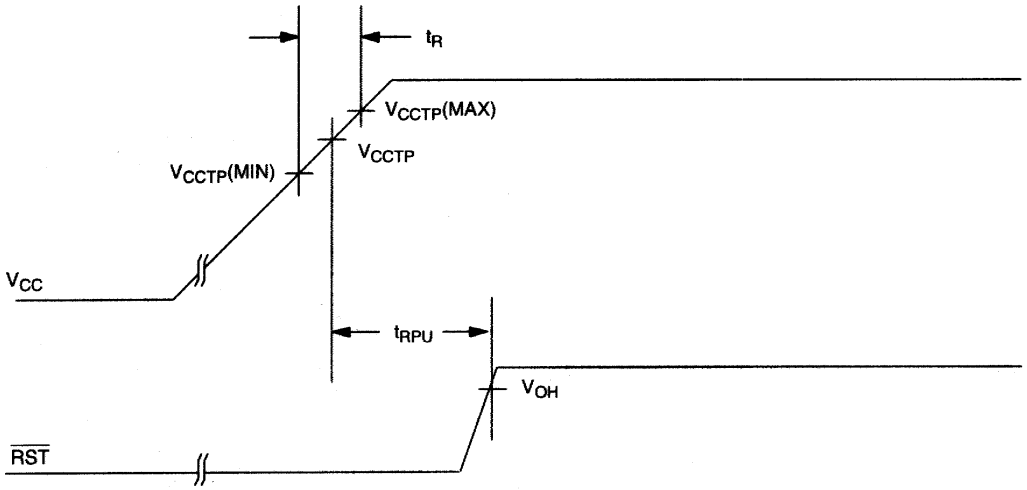
APPLICATION EXAMPLE Figure 2



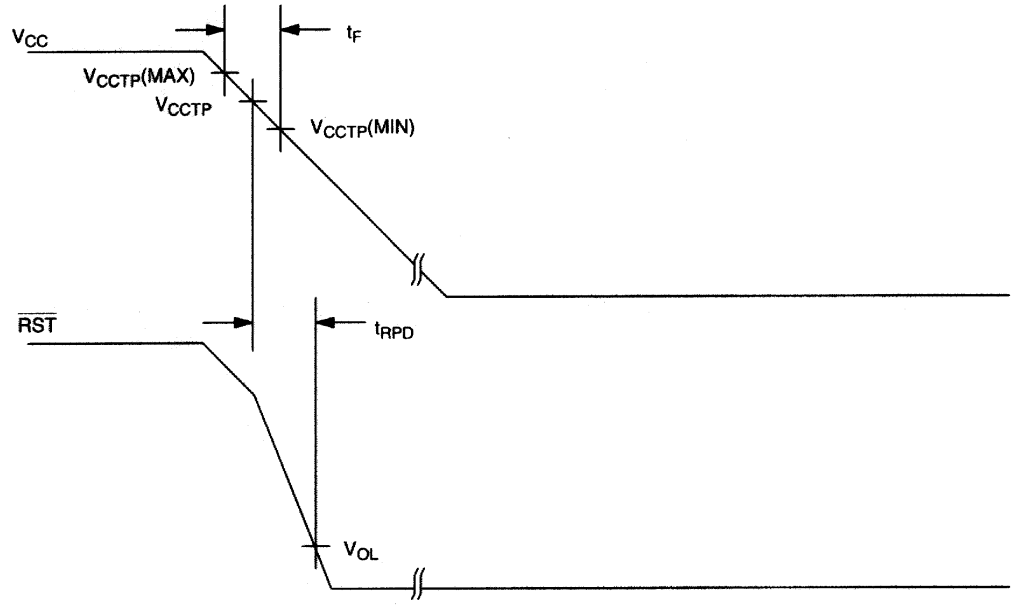
APPLICATION DIAGRAM: $\overline{RST}$ VALID TO 0 VOLTS V_{CC} ON THE DS1815 Figure 3



TIMING DIAGRAM: POWER-UP Figure 4



TIMING DIAGRAM: POWER-DOWN Figure 5



ABSOLUTE MAXIMUM RATINGS*

Voltage on V_{CC} Pin Relative to Ground	-0.5V to +7.0V
Voltage on $\overline{RST}$ Relative to Ground	-0.5V to +5V_{CC} +0.5V
Operating Temperature	-40°C to +85°C
Storage Temperature	-55°C to +125°C
Soldering Temperature	260°C for 10 seconds

* This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

RECOMMENDED DC OPERATING CONDITIONS (-40°C to +85°C)

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
Supply Voltage	V_{CC}	0.0		5.5	V	1

DC ELECTRICAL CHARACTERISTICS (-40°C to +85°C; V_{CC}=1.2V to 5.5V)

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
Output Voltage @ -500 µA	V_{OH}	V_{CC} -0.5V	V_{CC} -0.1V		V	1
Output Current @ 2.4 V	I_{OH}		350		µA	2
Output Current @ 0.4 V	I_{OL}	+10			mA	2
Operating Current V_{CC} < 5.5	I_{CC}		28	35	µA	3
V_{CC} Trip Point (DS1815-5)	V_{CCTP}	2.98	3.06	3.15	V	1
V_{CC} Trip Point (DS1815-10)	V_{CCTP}	2.80	2.88	2.97	V	1
V_{CC} Trip Point (DS1815-15)	V_{CCTP}	2.47	2.55	2.64	V	1
Output Capacitance	C_{OUT}			10	pF	

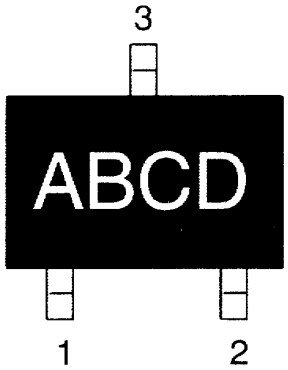
AC ELECTRICAL CHARACTERISTICS (-40°C to +85°C; V_{CC}=1.2V to 5.5V)

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	NOTES
RESET Active Time	t_{RST}	100	150	250	ms	4
V_{CC} Detect to $\overline{RST}$	t_{RPD}		2	5	µs	
V_{CC} Slew Rate (V_{CCTP} (MAX) to V_{CCTP} (MIN))	t_F	300			µs	6
V_{CC} Slew Rate (V_{CCTP} (MIN) to V_{CCTP} (MAX))	t_R	0			ns	
V_{CC} Detect to $\overline{RST}$	t_{RPU}	100	150	250	ms	4, 5

NOTES:

1. All voltages are referenced to ground.
2. Measured with $V_{CC} \geq 2.7V$.
3. Measured with $\overline{RST}$ output open.
4. Measured with $2.7V \leq V_{CC} \leq 3.3V$.
5. $t_R = 5\ \mu s$.
6. The t_F value is for reference in defining values for T_{RPD} and should not be considered a requirement for proper operation or use of the device.

PART MARKING CODES



"A", "B", &"C" represent the device type.

- 810 . . . . DS1810
- 811 . . . . DS1811
- 812 . . . . DS1812
- 813 . . . . DS1813
- 815 . . . . DS1815
- 816 . . . . DS1816
- 817 . . . . DS1817
- 818 . . . . DS1818

"D" represents the device tolerance.

- A 5%
- B 10%
- C 15%
- D 20%